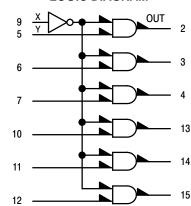
V<sub>CC1</sub> = PIN 1  $V_{CC2} = PIN 16$   $V_{EE} = PIN 8$ 

# **Hex Buffer With Enable**

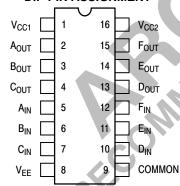
The MC10188 is a high-speed hex buffer with a common Enable input. When Enable is in the high state, all outputs are in the low state. When Enable is in the low state, the outputs take the same state as the inputs.

- Power Dissipation = 180 mW typ/pkg (No Load)
- Propagation Delay = 2.0 ns typ (B Q)2.5 ns typ (A - Q)

# LOGIC DIAGRAM



## **DIP PIN ASSIGNMENT**



Pin assignment is for Dual-in-Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 18 of the ON Semiconductor MECL Data Book (DL122/D).

# TRUTH TABLE

	TRUTH TABLE				
	Inputs				
	Х	Υ	OUT		
10	┙	L	L		
	L	Н	Н		
	Н	L	L		
O	Н	Н	L		



## http://onsemi.com

# **MARKING DIAGRAMS**

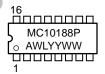


CDIP-16 **L SUFFIX CASE 620** 





PDIP-16 P SUFFIX **CASE 648** 





PLCC-20 **FN SUFFIX CASE 775** 



= Assembly Location

WL = Wafer Lot YY = Year WW = Work Week

# **ORDERING INFORMATION**

Device	Package	Shipping
MC10188L	CDIP-16	25 Units / Rail
MC10188P	PDIP-16	25 Units / Rail
MC10188FN	PLCC-20	46 Units / Rail

# **ELECTRICAL CHARACTERISTICS**

				Test Limits				_		
			Pin Under	-30	)°C	+2	5°C	+8	5°C	
Characteri	Characteristic		Symbol Test	Min	Max	Min	Max	Min	Max	Unit
Power Supply Drain Co	urrent	Ι <sub>Ε</sub>	8		46		42		46	mAdc
Input Current		I <sub>inH</sub>	5		425		265		265	μAdc
		I <sub>inH</sub>	9		460		290		290	μAdc
Output Voltage	Logic 1	V <sub>OH</sub>	2	-1.060	-0.890	-0.960	-0.810	-0.890	-0.700	Vdc
Output Voltage	Logic 0	V <sub>OL</sub>	2	-1.890	-1.675	-1.850	-1.650	-1.825	-1.615	Vdc
Threshold Voltage	Logic 1	V <sub>OHA</sub>	2	-1.080		-0.980		-0.910		Vdc
Threshold Voltage	Logic 0	V <sub>OLA</sub>	2		-1.655		-1.630		-1.595	Vdc
Switching Times	(50Ω Load)									ns
Propagation Delay	Enable Data	t <sub>PHL</sub> t <sub>PLH</sub>	2 2	1.1 1.0	3.9 3.3	1.1 1.0	3.5 2.9	1.1 1.0	3.9 3.3	
Rise/Fall Time	(20 to 80%)	t <sub>TLH</sub> t <sub>THL</sub>	2	1.1	3.7	1.1	3.3	1.1	3.7	

# **ELECTRICAL CHARACTERISTICS** (continued)

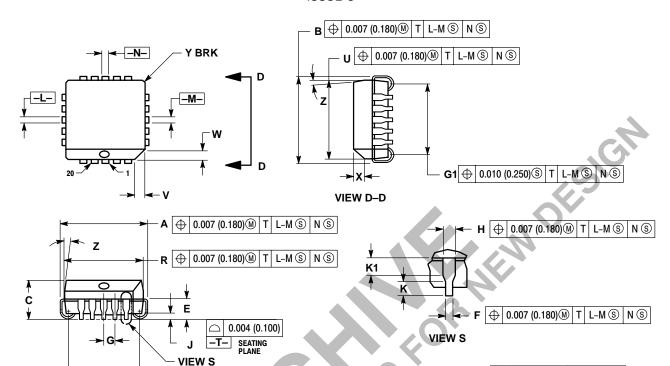
ELECTRICAL CHA	RACTERISTIC	S (continue	ed)				N	<b>\</b>	
					TEST VO	TAGE VALU	JES (Volts)		
@ Test Temperature			V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>		
			-30°C	-0.890	-1.890	-1.205	-1.500	-5.2	
			+25°C	-0.810	-1.850	-1.105	-1.475	-5.2	
			+85°C	-0.700	-1.825	-1.035	-1.440	-5.2	
			Pin	TEST V	OLTAGE AP	PLIED TO P	INS LISTED I	BELOW	]
Characteri	istic	Symbol	Under Test	V <sub>IHmax</sub>	V <sub>ILmin</sub>	V <sub>IHAmin</sub>	V <sub>ILAmax</sub>	V <sub>EE</sub>	(V <sub>CC</sub> ) Gnd
Power Supply Drain C	Current	IE	8					8	1, 16
Input Current		I <sub>inH</sub>	5	5				8	1, 16
		l <sub>inH</sub>	9	9				8	1, 16
Output Voltage	Logic 1	VoH	2	5				8	1, 16
Output Voltage	Logic 0	V <sub>OL</sub>	2		9			8	1, 16
Threshold Voltage	Logic 1	V <sub>OHA</sub>	2			5		8	1, 16
Threshold Voltage	Logic 0	V <sub>OLA</sub>	2				5	8	1, 16
Switching Times	(50Ω Load)					Pulse In	Pulse Out	-3.2 V	+2.0 V
Propagation Delay	Enable Data	t <sub>PHL</sub> t <sub>PLH</sub>	2 2			9 5	2 2	8 8	1, 16 1, 16
Rise/Fall Time	(20 to 80%)	t <sub>TLH</sub> t <sub>THL</sub>	2			5	2	8	1, 16

Each MECL 10,000 series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50-ohm resistor to -2.0 volts. Test procedures are shown for only one gate. The other gates are tested in the same manner.

#### PACKAGE DIMENSIONS

## PLCC-20 **FN SUFFIX**

PLASTIC PLCC PACKAGE CASE 775-02 ISSUE C



#### NOTES:

G1 ⊕ 0.010 (0.250)③ T L-M ⑤ N ⑤

OF MICE. NOT PERSON

- OTES:

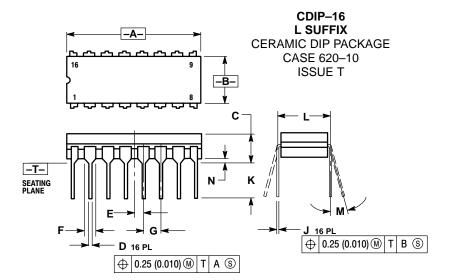
  1. DATUMS -L-, -M-, AND -N- DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.

  2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

  3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.

  4. DIMENSIONING AND TOLERANCING PER ANSI V14 5M 1982
- Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.385	0.395	9.78	10.03
В	0.385	0.395	9.78	10.03
С	0.165	0.180	4.20	4.57
Ε	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
J	0.020		0.51	
K	0.025		0.64	
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2°	10°	2 °	10 °
G1	0.310	0.330	7.88	8.38
<b>K</b> 1	0.040		1.02	



#### NOTES:

- ANIES.

  DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

  CONTROLLING DIMENSION: INCH.

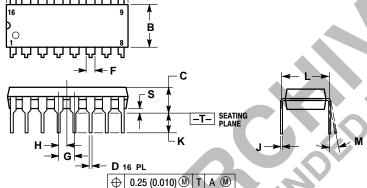
  DIMENSION L TO CENTER OF LEAD WHEN

- FORMED PARALLEL.
  DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC

	INC	HES	MILLIMETERS		
DIM	MIN	MAX	MIN	MAX	
Α	0.750	0.785	19.05	19.93	
В	0.240	0.295	6.10	7.49	
С		0.200		5.08	
D	0.015	0.020	0.39	0.50	
E	0.050	BSC	1.27 BSC		
F	0.055	0.065	1.40	1.65	
G	0.100	BSC	2.54 BSC		
Н	0.008	0.015	0.21	0.38	
K	0.125	0.170	3.18	4.31	
L	0.300	BSC	7.62	BSC 4	
М	0°	15°	0 °	15°	
N	0.020	0.040	0.51	1.01	

# PDIP-16 **P SUFFIX** PLASTIC DIP PACKAGE

CASE 648-08 ISSUE R



- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. CONTROLLING DIMENSION: INCH.
- DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- DIMENSION B DOES NOT INCLUDE MOLD FLASH.
  ROUNDED CORNERS OPTIONAL

	INC	HES	MILLIM	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.740	0.770	18.80	19.55	
В	0.250	0.270	6.35	6.85	
С	0.145	0.175	3.69	4.44	
D	0.015	0.021	0.39	0.53	
F	0.040	0.70	1.02	1.77	
G	0.100	BSC	2.54 BSC		
Н	0.050	BSC	1.27	BSC	
J	0.008	0.015	0.21	0.38	
K	0.110	0.130	2.80	3.30	
L	0.295	0.305	7.50	7.74	
M	0°	10°	0°	10 °	
S	0.020	0.040	0.51	1.01	
5	0.020	0.040	0.51	1.01	

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